

### **TS-WDM-0320B**

# 2.5Gbps SFP Bi-Directional Transceiver, 20km Reach 1310nm TX / 1550nm RX

### **Features**

- Up to 2.67Gb/s bi-directional data links
- 1310nm DFB laser and PIN photodetector for 20km transmission
- · Compliant with SFP MSA and SFF-8472 with simplex LC receptacle
- Digital Diagnostic Monitoring:
   Internal Calibration or External Calibration
- · Compatible with SONET OC-48 system
- · Compatible with RoHS
- +3.3V single power supply
- Operating case temperature range of 0°C to +70°C (Commercial) or -40°C to +85°C (Industrial)



### **Applications**

- SDH STM-16 and SONET OC-48 system
- 2X Fiber Channel
- · Switch to Switch interface
- Switched backplane applications
- Router/Server interface
- · Other optical transmission systems

### **Description**

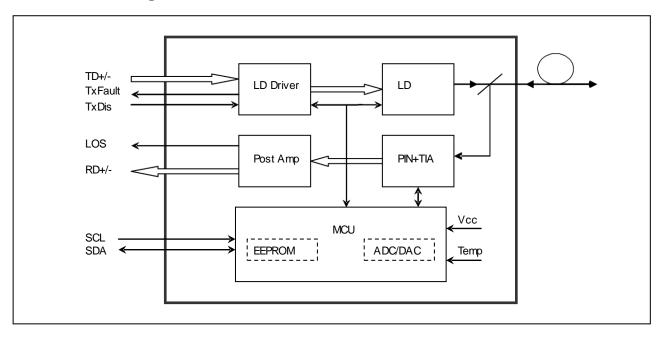
The SFP-BIDI transceivers are high performance, cost effective modules supporting data-rate of 2.5Gbps and 20km transmission distance with SMF.

The transceiver consists of three sections: a DFB laser transmitter, a PIN photodiode integrated with a trans-impedance preamplifier (TIA) and MCU control unit. All modules satisfy class I laser safety requirements.

The transceivers are compatible with SFP Multi-Source Agreement (MSA) and SFF-8472. For further information, please refer to SFP MSA.



## **Module Block Diagram**



### **Absolute Maximum Ratings**

Parameter	Symbol	Min	Max	Unit
Supply Voltage	Vcc	-0.5	4.5	V
Storage Temperature	Ts	-40	+85	°C
Operating Humidity	-	5	85	%

### **Recommended Operating Conditions**

Parameter		Symbol	Min	Typical	Max	Unit
Operating Cons Temperature	Commercial	Тс	0		+70	°C
Operating Case Temperature	Industrial		-40		+85	°C
Pow er Supply Voltage		Vcc	3.13	3.3	3.47	V
Pow er Supply Current		lcc			300	mA
Data Rate				2.5		Gbps



## **Optical and Electrical Characteristics**

Parai	neter	Symbol	Min	Typical	Max	Unit	Notes
		Transmitte	er				
Centre Wavelength		λс	1260	1310	1360	nm	
Spectral Width (-20dB)		Δλ			1	nm	
Side Mode Suppression R	atio	SMSR	30			dB	
Average Output Power		Pout	-5		0	dBm	1
Extinction Ratio		ER	8		10	dB	
Optical Rise/Fall Time (20	%~80%)	t <sub>r</sub> /t <sub>f</sub>			0.16	ns	
Data Input Swing Different	ial	V <sub>IN</sub>	400		1800	mV	2
Input Differential Impedance	е	Z <sub>IN</sub>	90	100	110	Ω	
TX Disable	Disable		2.0		Vcc	V	
	Enable		0		0.8	V	
T/ 5 11	Fault		2.0		Vcc	V	
TX Fault	Normal		0		0.8	V	
		Receive	•				
Centre Wavelength		λς	1530		1570	nm	
Receiver Sensitivity					-18	dBm	3
Receiver Overload			-3			dBm	3
LOS De-Assert	LOS De-Assert				-19	dBm	
LOS Assert		LOSA	-30			dBm	
LOS Hysteresis			1		4	dB	
Data Output Swing Differe	ntial	Vout	400		1800	mV	4
1.00		High	2.0		Vcc	V	
LUS	LOS				0.8	V	

#### Notes

- 1. The optical pow er is launched into SMF.
- 2. PECL input, internally AC-coupled and terminated.
- 3. Measured with a PRBS 2<sup>23</sup>-1 test pattern @2488Mbps, BER≤1×10<sup>-12</sup>.
- 4. Internally AC-coupled.

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Timing and Electrical

Parameter	Symbol	Min	Typical	Max	Unit
Tx Disable Negate Time	t_on			1	ms
Tx Disable Assert Time	t_off			10	μs
Time To Initialize, including Reset of Tx Fault	t_init			300	ms
Tx Fault Assert Time	t_fault			100	μs
Tx Disable To Reset	t_reset	10			μs
LOS Assert Time	t_loss_on			100	μs
LOS De-assert Time	t_loss_off			100	μs
Serial ID Clock Rate	f_serial_clock			400	KHz
MOD_DEF (0:2)-High	V <sub>H</sub>	2		Vcc	V
MOD_DEF (0:2)-Low	V <sub>L</sub>			0.8	V

**Diagnostics Specification** 

Parameter	Range	Unit	Accuracy	Calibration	
Tomogratura	0 to +70	°C	±3°C	Internal / External	
Temperature	-40 to +85		±3 C		
Voltage	3.0 to 3.6	V	±3%	Internal / External	
Bias Current	0 to 100	mA	±10%	Internal / External	
TX Power	-5 to 0	dBm	±3dB	Internal / External	
RX Power	-18 to -3	dBm	±3dB	Internal / External	

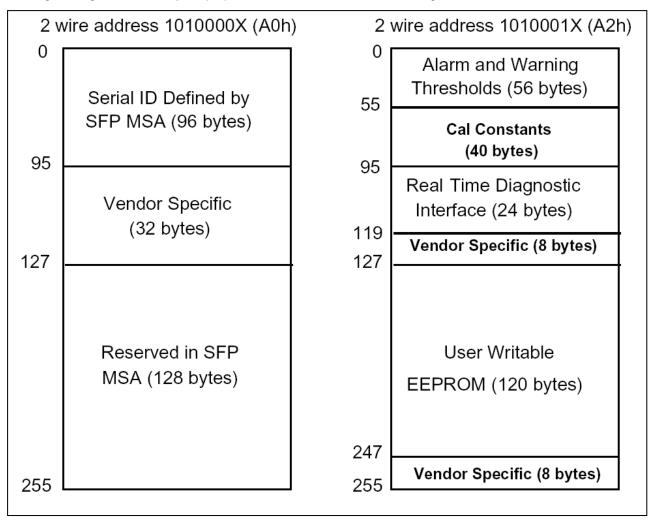


### **Digital Diagnostic Memory Map**

The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.





## SFP Transceiver Electrical Pad Layout

20 [	VeeT		1	VeeT
19 [	TD-		2	TxFault
18 [	TD+		3	Tx Disable
17 [	VeeT		4	MOD-DEF(2)
16 [	VccT		5	MOD-DEF(1)
15 [	VccR		6	MOD-DEF(0)
14 [	VeeR		7	Rate Select
13 [	RD+		8	LOS
12 [	RD-		9	VeeR
11 [	VeeR		10	VeeR
	Top of Board Board (as viewed thru top of board)			



### **Pin Descriptions**

Pin	Signal Name	Description	Plug Seq.	Notes
1	VeeT	Transmitter Ground	1	
2	TX Fault	Transmitter Fault Indication	3	Note 1
3	TX Disable	Transmitter Disable	3	Note 2
4	MOD_DEF(2)	SDA Serial Data Signal	3	Note 3
5	MOD_DEF(1)	SCL Serial Clock Signal	3	Note 3
6	MOD_DEF(0)	TTL Low	3	Note 3
7	Rate Select	Not Connect	3	
8	LOS	Loss of Signal	3	Note 4
9	VeeR	Receiver ground	1	
10	VeeR	Receiver ground	1	
11	VeeR	Receiver ground	1	
12	RD-	Inv. Received Data Out	3	Note 5
13	RD+	Received Data Out	3	Note 5
14	VeeR	Receiver ground	1	
15	VccR	Receiver Power Supply	2	
16	VccT	Transmitter Pow er Supply	2	
17	VeeT	Transmitter Ground	1	
18	TD+	Transmit Data In	3	Note 6
19	TD-	Inv. Transmit Data In	3	Note 6
20	VeeT	Transmitter Ground	1	

### Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

- 1) TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; Logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- 2) TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a 4.7k~10kΩ resistor. Its states are:

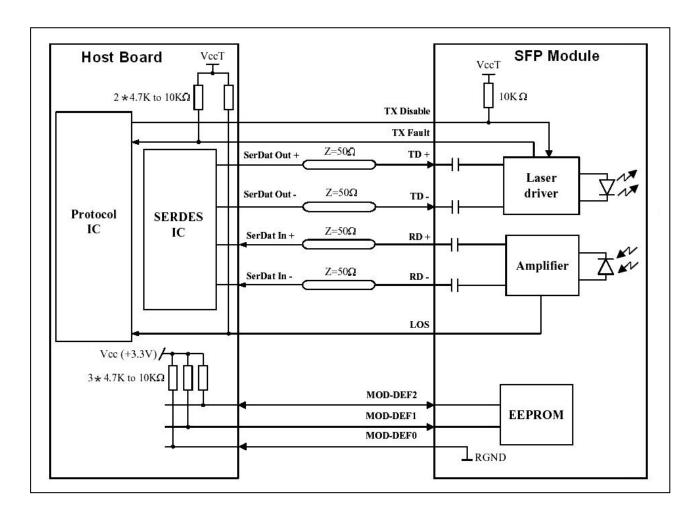
Low (0 to 0.8V): Transmitter on (>0.8V, < 2.0V): Undefined

High (2.0 to 3.465V): Transmitter Disabled Open: Transmitter Disabled

- 3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a  $4.7k\sim10k\Omega$  resistor on the host board. The pull-up voltage shall be VccTor VccR
  - Mod-Def 0 is grounded by the module to indicate that the module is present
  - Mod-Def 1 is the clock line of two wire serial interface for serial ID
  - Mod-Def 2 is the data line of twow ire serial interface for serial ID
- 4) LOS is an open collector output, which should be pulled up with a  $4.7k\sim10k\Omega$  resistor. Pull up voltage between 2.0V and Vcc+0.3V. Logic 1 indicates loss of signal; Logic 0 indicates normal operation. In the low state, the output will be pulled to less than 0.8V.
- 5) RD-/+: These are the differential receiver outputs. They are internally AC-coupled 100 differential lines which should be terminated with  $100\Omega$  (differential) at the user SERDES.
- 6) TD-/+: These are the differential transmitter inputs. They are internally AC-coupled, differential lines with 100Ω differential termination inside the module.

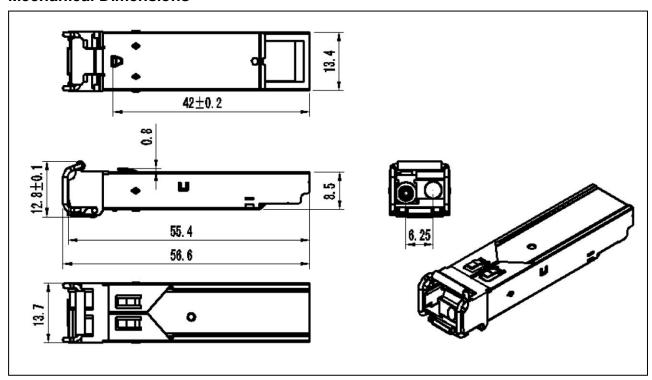


### **Recommended Interface Circuit**





## **Mechanical Dimensions**



## **Regulatory Compliance**

Feature	Stand ard	Perform ance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883E Method 3015.7	Class 1(>500 V) Isolation with the case
Electromagnetic Interference (EMI)	FCC Part 15 Class B	Compatible with standards
Laser Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN60950, EN (IEC) 60825-1,2	Compatible with Class I laser product. Compatible with TüV standards
Component Recognition	UL and CUL	UL file E317337
Green Products	2002/95/EC 2005/618/EC	RoHS6



### **Ordering information**

Part Number	Product Description
TS-WDM-0320B	Tx1310/Rx1550nm, 2.5Gbps, LC, 20km, 0°C~+70°C
TS-WDM-0320DB	Tx1310/Rx1550nm, 2.5Gbps, LC, 20km, 0°C~+70°C, With Digital Diagnostic Monitoring
TS-WDM-0320 IB	Tx1310/Rx1550nm, 2.5Gbps, LC, 20km, -40°C~+85°C
TS-WDM-0320 DIB	Tx1310/Rx1550nm, 2.5Gbps, LC, 20km, -40°C~+85°C, With Digital Diagnostic Monitoring

### References

- 1. Small Form Factor Pluggable (SFP) Transceiver Multi-Source Agreement (MSA), September 2000.
- 2. Telcordia GR-253-CORE and ITU-T G.957 Specifications.

### **Important Notice**

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